

Specification Page 8 - Amended without Underlining and
Strikethroughs - Clean Version

The bundling portion connecting filaments to each other may be provided linearly in a direction crossing the filaments.

The bonding portion between the filament bundling body connecting the filaments to each other and the base material sheet may be provided linearly or in the form of a plurality of spots.

The filament bundling body may be bonded to the base material sheet at the bonding portion of a predetermined width located at a substantially central position with respect to the fiber direction.

The adhesive used is preferably a hot melt type adhesive and may contain a coloring agent.

The base material sheet may have a handle mounting portion.

The fiber bundle may be provided on both the upper and lower sides of the base material sheet.

A process for producing a cleaning device according to the present invention includes: aligning a large number of filaments with fusibility in fiber direction; fusing together the substantially central portions of the filaments by fusing means to form a filament bundling body;

applying an adhesive to the position corresponding to a bonding portion between the filament bundling body and a base material sheet; stacking together the filament bundling body and the base material sheet; and bonding together the filament bundling body and the base material sheet at the position of the bonding portion.